

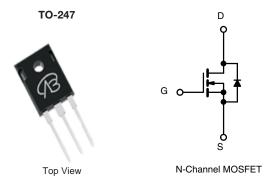
N-Channel 250 V (D-S) MOSFET

| PRODUCT | SUMMARY | | |
|---------------------|--------------------------------|--------------------|-----------------------|
| V _{DS} (V) | R _{DS(on)} (Ω) MAX. | I _D (A) | Q _g (TYP.) |
| 250 | 0.016at V _{GS} = 10 V | 100 | 75nC |

FEATURES

- SGT technology Power MOSFET
- \bullet 100 % R_g and UIS tested
- Maximum 150 °C junction temperature





APPLICATIONS

- Power supplies:
 - Uninterruptible power supplies
 - AC/DC switch-mode power supplies
 - Lighting
- Synchronous rectification
- DC/DC converter
- Motor drive switch
- DC/AC inverter
- Solar micro inverter
- Class D audio amplifier

| ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted) | | | | | | |
|--|-------------------------|-----------------------------------|------------------|------|--|--|
| PARAMETER | | SYMBOL | LIMIT | UNIT | | |
| Drain-Source Voltage | | V _{DS} | 250 | V | | |
| Gate-Source Voltage | V _{GS} | ± 20 | 7 v | | | |
| Continuous Dunis Comment (T. 150 °C) | T _C = 25 °C | | 100 | | | |
| Continuous Drain Current (T _J = 150 °C) | T _C = 70 °C | ─ I _D | 80 | | | |
| Pulsed Drain Current (t = 100 μs) | | I _{DM} | 300 | A | | |
| Avalanche Current | L = 0.5 mH | I _{AS} | 650 | | | |
| Single Avalanche Energy ^a | L = 0.5 IIII | E _{AS} | 105 | mJ | | |
| Movimum Dower Dissination 8 | T _C = 25 °C | В | 300 ^b | W | | |
| Maximum Power Dissipation ^a | T _C = 100 °C | P _D | 150 ^b |] vv | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | -55 to +150 | °C | | |

| THERMAL RESISTANCE RATINGS | | | |
|--|-------------------|-------|-------|
| PARAMETER | SYMBOL | LIMIT | UNIT |
| Junction-to-Ambient (PCB Mount) ^c | R _{thJA} | 40 | °C/W |
| Junction-to-Case (Drain) | R _{thJC} | 0.5 |] C/W |

Notes

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.
- c. When mounted on 1" square PCB (FR4 material).

服务热线:400-655-8788

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| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|----------------------|---|------|-------|-------|------|
| Static | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 250 | - | - | V |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_D = 250 \mu A$ | 2.5 | - | 4.5 | V |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | - | - | ± 250 | nA |
| | | V _{DS} = 160 V, V _{GS} = 0 V | - | - | 1 | ^ |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 160 V, V _{GS} = 0 V, T _J = 125 °C | - | - | 150 | μA |
| | | V _{DS} = 160 V, V _{GS} = 0 V, T _J = 150 °C | - | - | 5 | mA |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$ | 90 | - | - | Α |
| Duain Calumas On State Desistance 2 | Б | V _{GS} = 10 V, I _D = 30 A | - | 0.016 | - | 0 |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = 7.5 V, I _D =30 A | - | 0.020 | - | Ω |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 30 A | - | 75 | - | S |
| Dynamic ^b | | | | | | |
| Input Capacitance | C _{iss} | | - | 2300 | - | pF |
| Output Capacitance | C _{oss} | V _{GS} = 0 V, V _{DS} = 60 V, f = 1 MHz | - | 246 | - | |
| Reverse Transfer Capacitance | C _{rss} | | - | 21 | - | |
| Total Gate Charge ^c | Qg | | - | 75 | 96 | |
| Gate-Source Charge ^c | Q _{gs} | $V_{DS} = 60 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 60 \text{ A}$ | - | 16.7 | - | nC |
| Gate-Drain Charge ^c | Q _{gd} | | - | 16.9 | - | |
| Gate Resistance | R_g | f = 1 MHz | 1.5 | 3 | 6 | Ω |
| Turn-On Delay Time ^c | t _{d(on)} | | - | 21 | 33 | |
| Rise Time ^c | t _r | V_{DD} = 60 V, R_L = 1.66 Ω | - | 20 | 50 | ns |
| Turn-Off Delay Time ^c | t _{d(off)} | $ID\cong 60 \text{ A}$, $VGEN = 10 \text{ V}$, $Rg = 1 \Omega$ | - | 33 | 71 | |
| Fall Time ^c | t _f | | - | 30 | 55 | |
| Drain-Source Body Diode Ratings at | nd Characteri | stics ^b (T _C = 25 °C) | | | | |
| Pulsed Current (t = 100 μs) | I _{SM} | | - | - | 300 | А |
| Forward Voltage ^a | V _{SD} | I _F = 10 A, V _{GS} = 0 V | - | 0.8 | 1.2 | V |
| Reverse Recovery Time | t _{rr} | | - | 35 | - | ns |
| Peak Reverse Recovery Charge | I _{RM(REC)} | $I_F = 30 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$ | - | 11 | 20 | Α |
| Reverse Recovery Charge | Q _{rr} | | - | 0.9 | 1.8 | μC |

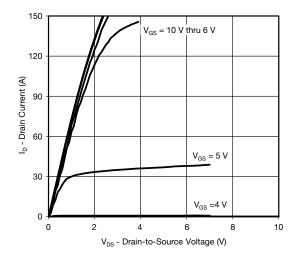
Notes

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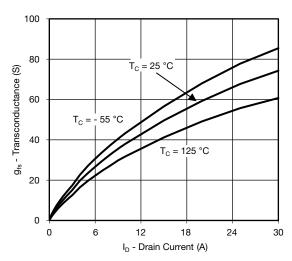
- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing. c. Independent of operating temperature.



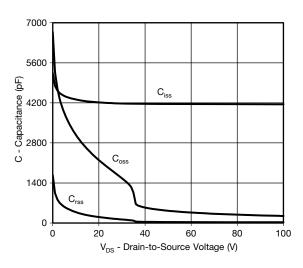
TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)



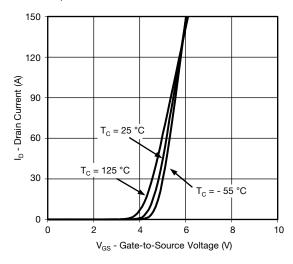




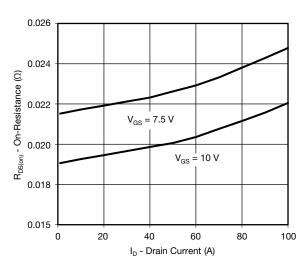
Transconductance



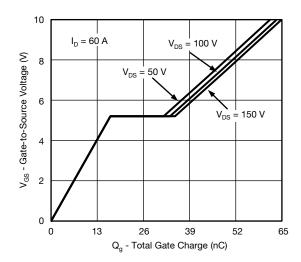
Capacitance



Transfer Characteristics



On-Resistance vs. Drain Current

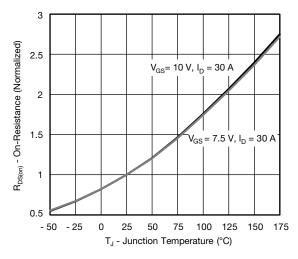


Gate Charge

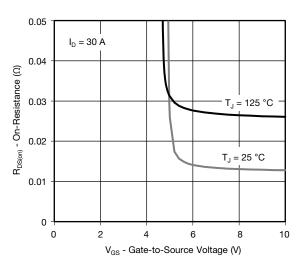
服务热线:400-655-8788 3



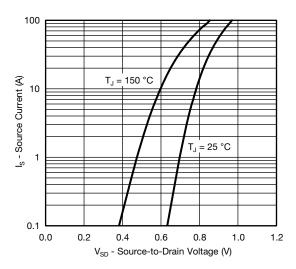
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



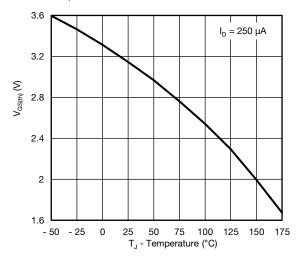
On-Resistance vs. Junction Temperature



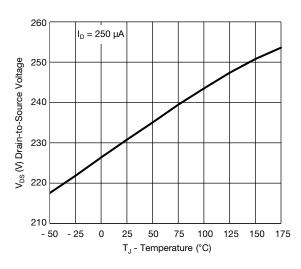
On-Resistance vs. Gate-to-Source Voltage



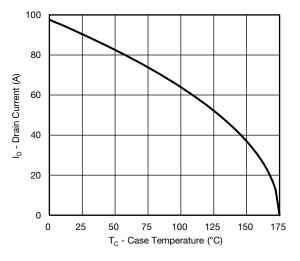
Source Drain Diode Forward Voltage



Threshold Voltage



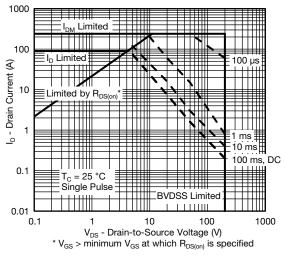
Drain Source Breakdown vs. Junction Temperature

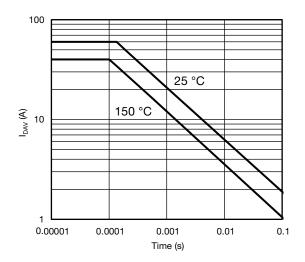


Current De-rating



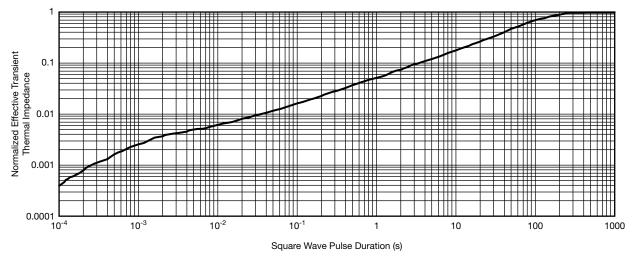
THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)





Safe Operating Area

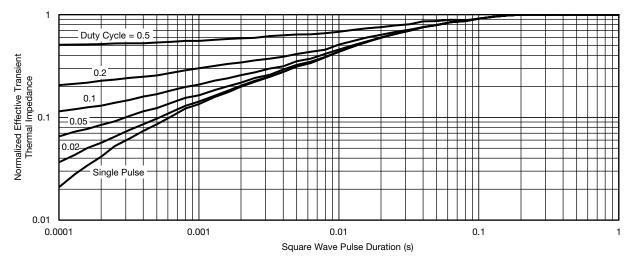
Single Pulse Avalanche Current Capability vs. Time



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

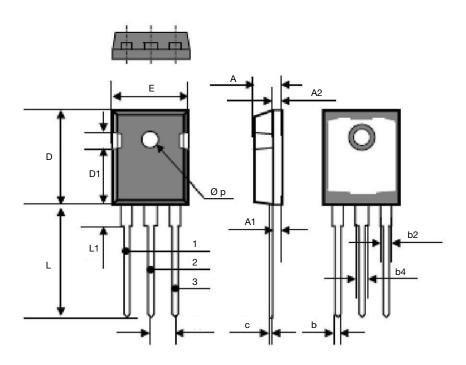
Note

- The characteristics shown in the two graphs Normalized Transient Thermal Impedance Junction to Ambient (25 $^{\circ}\text{C})$
 - Normalized Transient Thermal Impedance Junction to Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



TO-247



| DIM. | MILLIMETERS | | INCHES | | |
|------|-------------|----------|-----------|-----------|--|
| | MIN. | MAX. | MIN. | MAX. | |
| Α | 4.70 | 5.31 | 0.185 | 0.209 | |
| A1 | 2.21 | 2.59 | 0.087 | 0.102 | |
| A2 | 1.50 | 2.49 | 0.059 | 0.098 | |
| b | 0.99 | 1.40 | 0.039 | 0.055 | |
| b2 | 1.65 | 2.41 | 0.065 | 0.095 | |
| b4 | 2.59 | 3.43 | 0.102 | 0.135 | |
| С | 0.61 | 0.61 BSC | | 0.024 BSC | |
| D | 20.80 | 21.46 | 0.819 | 0.845 | |
| D1 | 3.68 | 5.49 | 0.145 | 0.216 | |
| (e) | 5.46 BSC | | 0.215 BSC | | |
| E | 15.49 | 16.26 | 0.610 | 0.640 | |
| L | 19.81 | 20.32 | 0.780 | 0.800 | |
| L1 | 4.06 | 4.50 | 0.160 | 0.177 | |
| Øр | 3.51 | 3.66 | 0.138 | 0.144 | |



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